

Instruction manual and data sheet PCA-30-10-10-1040-x

Photoconductive THz antenna for laser excitation wavelengths λ ~ 1040 nm $\mbox{PCA} - \mbox{Photoconductive Antenna}$

PCA-30-10-10-1040-0 - unmounted antenna chip 2 mm x 2 mm with 4 bond contact pads
PCA-30-10-10-1040-h - mounted antenna on hyperhemispherical silicon substrate lens
PCA-30-10-10-1040-a - mounted antenna on aspheric silicon substrate lens

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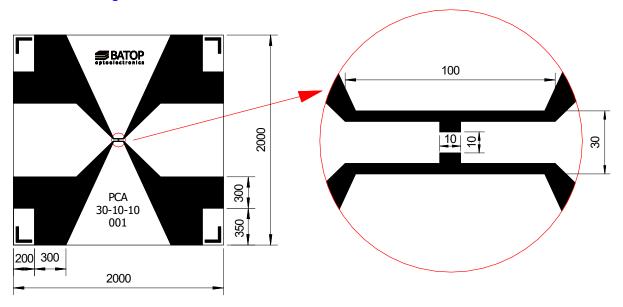
1. PCA applications

The PCA can be used as terahertz (THz) emitter or detector in pulsed laser gated broadband THz measurement systems for time-domain spectroscopy and as photomixing emitter or detector in tunable cw THz measurement systems in the frequency region from 0.1 to 3 THz.

Main PCA data

- Laser excitation wavelength λ ~ 1040 nm
- Antenna resonance frequency 1.5 THz

2. Antenna design



all dimensions in micrometers

Photo PCA 30-10-10 (survey)

Photo PCA 30-10-10 (detail)

dielectric cover

Pen 38-18-18

B22

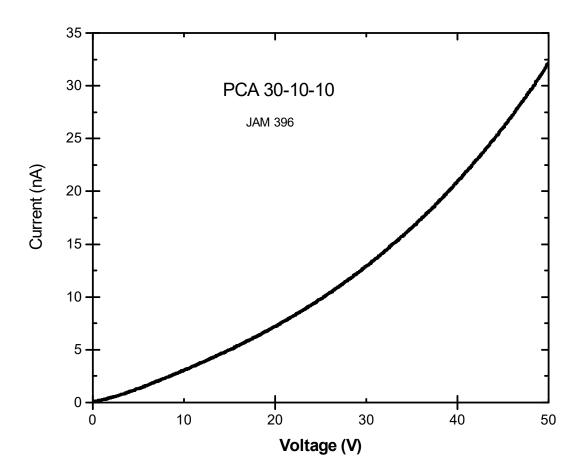


3. Antenna parameters

Electrical parameters

Parameter	minimum ratings	standard	maximum ratings
Dark resistance	5 GΩ	8 GΩ	15 GΩ
Dark current @ 10 V	1 pA	3 nA	10 nA
Voltage		30 V	40V

Dark current voltage characteristic at T = 300 K

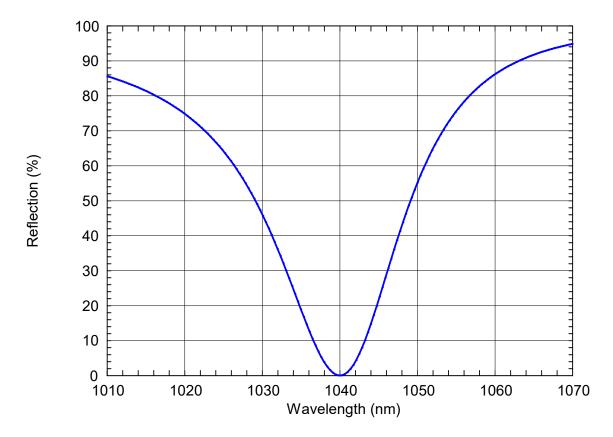




Optical excitation parameters

Parameter	minimum ratings	standard	maximum ratings
Excitation laser wavelength	1030 nm	1040 nm	1050 nm
Optical reflectance	0.5 %	2 %	5 %
Optical mean power		40 mW	80 mW
Carrier recovery time		300 fs	

Spectral reflectance





4. Mounted PCA on hyperhemispherical silicon substrate lens: PCA-30-10-10-1040-h

Photoconductive antenna substrate semi-insulating GaAs

chip area 2 mm x 2 mm

thickness t 600 µm

Hyperhemispherical lens material undoped HRFZ-silicon,

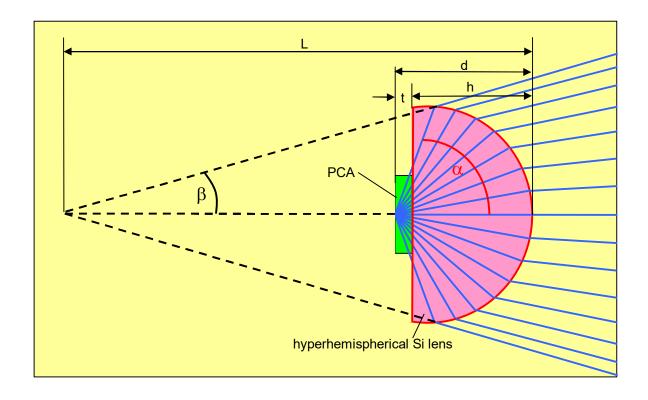
specific resistance ρ >10 k Ω cm

refractive index n 3.4
diameter 12 mm
height h 7.1 mm
distance d 7.7 mm

Terahertz beam collection angle α 57°

divergence angle ß 15°

virtual focus length L 26.4 mm



Aluminium mount 25.4 mm diameter, 6 mm thick

Coaxial cable type RG178 B/U, impedance 50Ω, capacitance 96pF/m, 1 m long

Connector type BNC or SMA

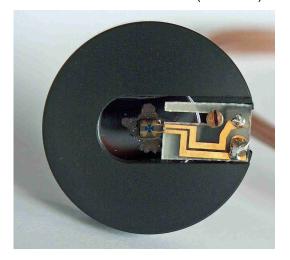


- The PCA chip is optically adjusted and glued on the hyperhemispherical silicon lens. The alignment of the PCA chip centre is done with respect to the optical axis of the silicon lens.
- The silicon lens is glued on the aluminium mount.
- The two antenna contacts are wire bonded on a printed circuit board, which provides the connection to a 1m long coaxial cable with BNC or SMA connector
- A central hole in the aluminium mount allows the Terahertz radiation to escape from the hyperhemispherical silicon lens

PCA with hyperhemispherical silicon lens, coaxial cable RG 178 and BNC connector



Front view on mounted PCA (laser side)

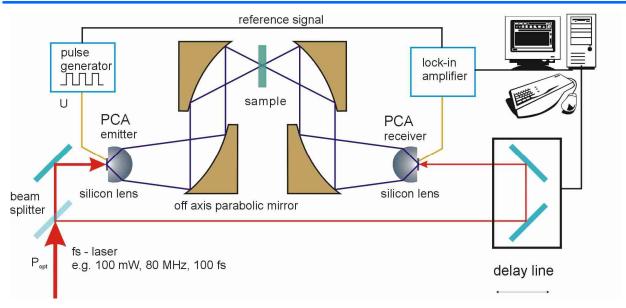


Back view on mounted PCA (THz side)

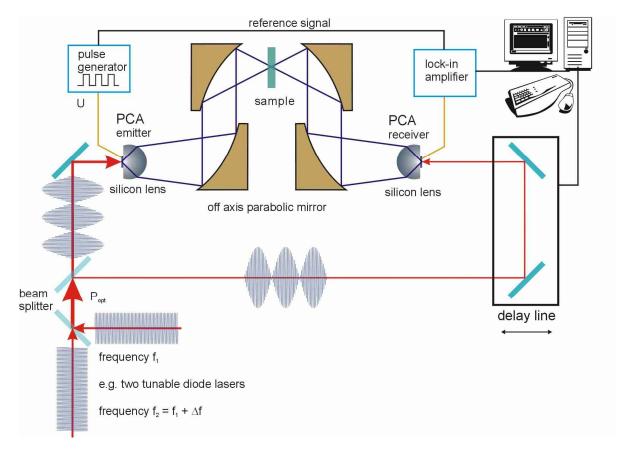


The antenna can be used as terahertz emitter or detector in pulsed laser gated broadband THz measurement systems for time-domain spectroscopy and as photomixing emitter or detector in tunable cw THz measurement systems in the frequency region from 0.1 to 3 THz (see schematics below).





Schematic of a time-domain spectroscopy setup



Photomixing setup

5. Mounted PCA on aspheric silicon substrate lens: PCA-30-10-10-1040-a

Photoconductive antenna substrate semi-insulating GaAs

chip area 2 mm x 2 mm

thickness t 600 µm



Aspheric lens material undoped HRFZ-silicon

specific resistance ρ >10 k Ω cm

refractive index n 3.4 diameter 12 mm height h 8 mm distance d 8.6 mm

rough AR surface

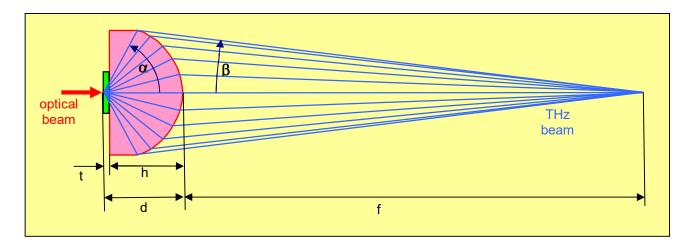
Terahertz beam focal length f 50 mm

collection angle α 57.6°

convergence angle ß 6.8°

Airy disc diameter at 300 GHz 5 mm

at 1 THz 1.5 mm at 3 THz 0.5 mm



Aluminium mount 25.4 mm diameter, 6 mm thick

Coaxial cable type RG178 B/U, impedance 50Ω , capacitance 96pF/m, 1 m long

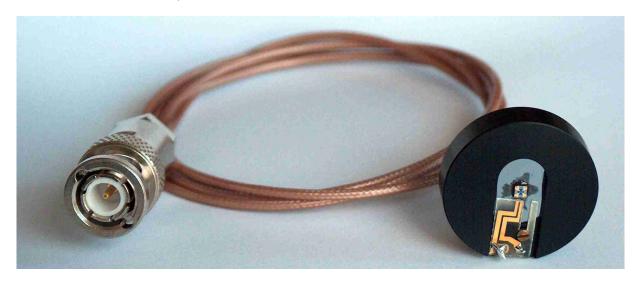
Connector type BNC or SMA

 The PCA chip is optically adjusted and glued on the aspheric silicon lens. The alignment of the PCA chip centre is done with respect to the optical axis of the silicon lens.

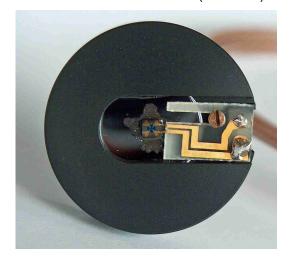
- The silicon lens is glued on the aluminium mount.
- The two antenna contacts are wire bonded on a printed circuit board, which provides the connection to a 1m long coaxial cable with BNC or SMA connector
- A central hole in the aluminium mount allows the Terahertz radiation to escape from the aspheric silicon lens as a collimated beam with a focus 50 mm away and an Airy disc diameter dependent on the THz frequency.



PCA with aspheric silicon lens, coaxial cable RG 178 and BNC connector



Front view on mounted PCA (laser side)

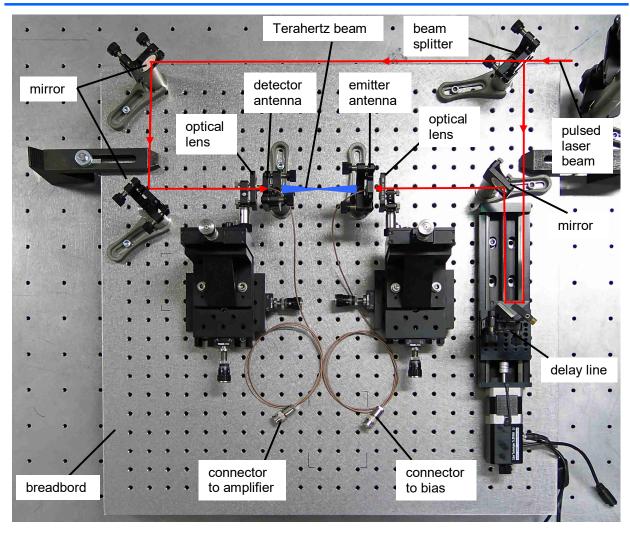


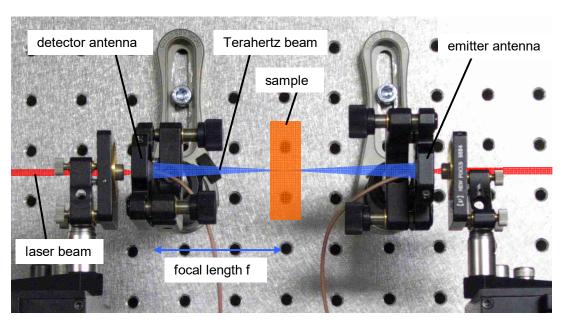
Back view on mounted PCA (THz side)



Terahertz time-domain spectrometer with two photoconductive antennas on aspheric lenses







Extended view of the Terahertz light path with sample

Bias voltage of the emitter antenna:

dc voltage: In this case the dc output voltage of the detector antenna (typical in the region of 1
 .. 100 mV) can be measured using a dc voltage amplifier.



ac voltage: As a result of the emitter square wave bias voltage between -V .. +V the detector
antenna delivers an ac voltage, which can be phase sensitive measured using a lock-in
detector

6. Instructions for use of the PCA-30-10-10-1040-x

Emitter:

The pulsed laser beam (in case of time domain spectroscopy) or the mixed cw laser beam (in case of cw THz emitter) has to be focussed onto the antenna gap using an appropriate lens or objective with a beam diameter of about 10 μ m to bridge the antenna gap with photo-excited carriers within the semiconductor. At the same time a voltage U of ~ 30 V (maximum 40 V peak voltage) has to be supplied on the gap by connecting the BNC connector cable to a voltage source. The recommended optical mean laser power P is 40 mW (maximum 80 mW).

Receiver:

The pulsed laser beam (in case of time domain spectroscopy) or the mixed cw laser beam (in case of cw THz emitter) has to be focussed onto the antenna gap using an appropriate lens or objective with a beam diameter of about 10 µm to bridge the antenna gap with photo-excited carriers within the semiconductor. The phase of the laser beam with respect to the beam on the emitter site has to be adjusted by using an optical delay line in such a way, that the measured value of the THz field on the antenna meets a maximum of the optical beam. By changing the phase difference between the emitter and receiver antenna the time-dependent shape of the THz field can be measured.

The cable with the BNC connector must be connected with a sensitive electronic current amplifier.

Attention: Please be sure, that the focusing lens or the lens mounting parts does not touch the antenna chip or the tiny gold contact wires between the antenna chip and the PCB. See figure "front view on mounted PCA (laser side)" above.

Lock-in detection

Because of the very small detector signal a lock-in detection scheme is recommended. The following two possibilities for lock-in detection can be used:

- An optical chopper can be used in front of the emitter antenna to chop the optical beam with a frequency ~ 1 kHz. The result is a chopped emitted THz signal, which meets the detector antenna. The output of the detector antenna is than a chopped current, which can be amplified using an ac amplifier and rectified using a standard lock-in system. The disadvantage of this system is the loss of 50 % of the optical excitation power on the emitter antenna.
- A square wave voltage generator with an output voltage U of maximum +/- 40 V and a frequency of some kHz can be used as supply for the emitter antenna. The result is an emitted



alternating THz signal, which meets the detector antenna. The output of the detector antenna is than an alternating current, which can be amplified using an ac amplifier and rectified using a standard lock-in system. This setup is shown in the figures above.

Direct voltage detection

If the THz signal is large enough, a direct dc voltage detection scheme can be used. In this case the emitter antenna has to be supplied by a dc voltage U of up to 40 V. The detector antenna rectifies the THz signal like in a lock-in system using the delay line for adjusting the optical reference signal. The maximum antenna output voltage is in the region of ~ 10 mV and the current ~ 1 nA. In this case a low drift dc current amplifier is needed to increase the signal level for registration.

7. Order information

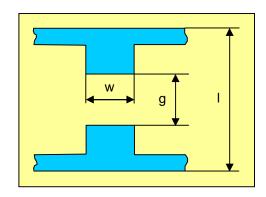
PCA-30-10-10-1040-x Photoconductive antenna

length I = 30 µm

gap $g = 10 \mu m$

width $w = 10 \mu m$

laser wavelength λ = 1040 nm



x denotes the type of mounting as follows:

x = 0 unmounted chip 2 mm x 2 mm with bond contact pads 300 μm x 650 μm

x = h mounted on an Al disc with 25.4 mm \emptyset and hyperhemispherical silicon

substrate lens, 1m coaxial cable with BNC or SMA connector

x = a mounted on an Al disc with 25.4 mm \emptyset and aspheric silicon substrate lens, 1m

coaxial cable with BNC or SMA connector